MATION DISCLOSURE STATEMENT BY APPLICANT

Attorney Docket Number	2815-66951
Application Number	10/674,361
Filing Date	September 29, 2003
First Named Inventor	Yang-Ki Hong
Art Unit	2818
Examiner Name	To be assigned

		Examiner Name To be assigned
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EXAMINER SIGNATURE: TUAN NGUYEN DATE CONSIDERED: 10/15/05

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Attorney Docket Number 2815-66951 **Application Number** To be assigned INFORMATION DISCLOSURE STATEMENT Filing Date Herewith BY APPLICANT First Named Invent r Yang-Ki Hong Art Unit To be assigned **Examiner Name** To be assigned **U.S. PATENT DOCUMENTS** Examiner's Cite No. Number Date Name (optional) Initials* 5,629,922 13 May 1997 Moodera et al. 5,923,583 13 July 1999 Womack 5,969,978 19 Oct 1999 **Prinz** 6,292,389 18 Sept 2001 Chen et al. 6,396,735 28 May 2002 Michijima et al. US2002/0109172A1 Bu 15 Aug 2002 Okazawa FOREIGN PATENT DOCUMENTS Examiner's Cite No. Number Date Initials* (optional) Country Examiner's Cite No. OTHER DOCUMENTS Initials* (optional) Kläui et al., Applied. Physics Letters 81(1):108-110, 2002 Lopez-Diaz et al., IEEE Transactions on Magnetics 36(5):3155-3157, 2000 Lopez-Diaz et al., Journal of Applied Physics 89(11):7579-7581, 2001 Rothman et al., Physical Review Letters 86(6):1098-1101, 2001

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